## **SPECIFICATION**

SMD INDUCTOR	
NRS4018 TYPE	
Magnetic Shielded Type	
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### **TAIYO YUDEN**

## Specifications (1/13) NRS4018 TYPE

#### 1. Range of application

This specifications are applied to SMD Inductor, NRS4018.

2. Ordering code

Example:  $NRS = 4018 \quad T = 100 \quad M = 100 \quad (6)$ 

- (1) Type
- (2) External dimensions
- (3) Packing style (T: Tape & Reel)
- (4) Inductance
- (5) Inductance tolerance
- (6) Internal Code

#### 3. Standard measuring method

Inductance : LCR meter (HP 4285A or equivalent, 100kHz, 1V)

Self-resonant : Impedance/Material (HP 4291A or equivalent)

frequency Analyzer

DC resistance : DC Ohmmeter (HIOKI 3227 or equivalent)

Standard test conditions for electrical characteristics

Unless otherwise specified, temperature is at 20±15 deg C and humidity is at 65±20 %.

Should any doubt arise about the test results, further test shall be conducted at a

temperature 20±2 deg C and humidity 65±5 %.

For inductance, our measured values shall be standard.

#### 4. Operating temperature range

-25 deg C to +125 deg C (Including self-heating)

#### 5. Storage temperature range

-40 deg C to + 85 deg C (For products in unopened tape package, -5 to 40 deg)

#### 6. Electrical characteristics

Refer to table 1.

#### 7. External dimensions and structural drawing

Refer to Table 2.

#### 8. Mechanical performance

Refer to Table 3.

#### 9. Environment test performance specifications

Refer to Table 3.

#### 10. Tape and Reel packaging dimensions

Refer to Table 4.

#### 11. Packing form

Refer to Table 5.

#### 12. Reflow profile chart

Refer to Table 6.

	Table 1	
(2/13)	ELECTRICAL CHARACTERISTICS	

Ordering Code	Nominal Inductance [ $\mu$ H]	Inductance Tolerance	D.C. Resistance ±20%	Rated Current [mA]		Self-resonant Frequency Min	
		[μ <b>H</b> ]	[%]	[Ω]	Saturation Current Idc1	Temperature Rise current Idc2	[MHz]
NRS4018T 1R0NDGJ	Α	1.0	±30	0.027	4000	3200	90
NRS4018T 2R2MDGJ	O	2.2	±20	0.042	3000	2200	60
NRS4018T 3R3MDGJ	Ш	3.3	±20	0.055	2300	2000	45
NRS4018T 4R7MDGJ	Ι	4.7	±20	0.070	2000	1700	35
NRS4018T 6R8MDGJ	I	6.8	±20	0.098	1600	1450	30
NRS4018T 100MDGJ	K	10	±20	0.150	1300	1200	25
NRS4018T 150MDGJ	М	15	±20	0.210	1100	850	18
NRS4018T 220MDGJ	N	22	±20	0.290	900	720	15
NRS4018T 330MDGJ	Р	33	±20	0.480	700	550	12

<sup>\*)</sup> The saturation current value (ldc1) is the DC current value having inductance decrease down to 30%. (at 20 deg C)

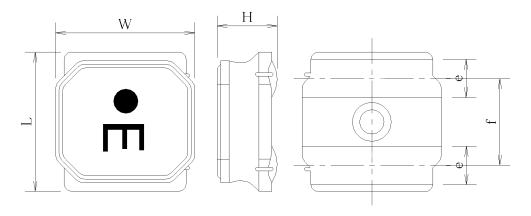
<sup>\*)</sup> The temperature rise current value (ldc2) is the DC current value having temperature increase up to  $40^{\circ}$ C.(at 20 deg C)

<sup>\*)</sup> The rated current is the DC current value that satisfies both of current saturation current value and temperature rise current value.

(3/13)

## EXTERNAL DIMENSIONS AND STRUCTURAL DRAWING

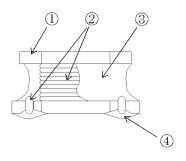
#### 1. External dimensions



Description	Mark	Dimensions
Length	L	4.0±0.2
Width	W	4.0±0.2
Height	Н	1.8Max.
Width of Electrode	е	1.1±0.2
Space between electrodes	f	2.5±0.2

(Unit: mm)

#### 2. Structural drawing



(Magnetic Shielded Type)

① Ferrite core Ni-Zn ferrite

② Winding wire Polyurethane-copper wire

③ Over-coating resin Epoxy resin, containing ferrite powder

4 Electrode External electrode (substrate)External electrode (base plating)Ni-Sn

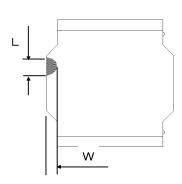
External electrode (top surface solder coating) Sn-Ag-Cu

(4/13)

EXTERNAL DIMENSIONS AND STRUCTURAL DRAWING

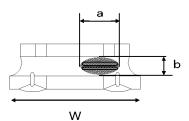
3. Core chipping

The appearance standard of the chipping size in top side, of bottom side ferrite core is following dimension.

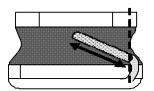


L	W
1.0mmMax.	1.0mmMax.

4. Exposed wire tolerance limit of coating resin part on product side Size of exposed wire occurring to coating resin is specified below.



- ① Width direction(dimension a) : Acceptable when a<=w/2
  Nonconforming when a>w/2
- ② Length direction (dimension b): Dimension b is not specified.
- When total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, that is acceptable.
- 5. External appearance criterion for exposed wire Exposed end of the winding wire at the secondary side should be 2mm and below.



(5/13)

EXTERNAL DIMENSIONS AND STRUCTURAL DRAWING

6. Electrode appearance criterion for exposed wire

<Cross section of wire joint part>

<Appearance judgment>

Only top side of wire is exposed.
egardless of whole tope side of wire exposed)

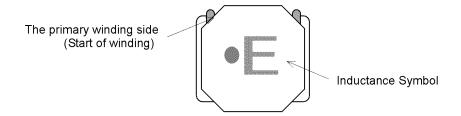
Conforming



Vire is soldered insufficiently and ess than half of outer diameter is covered with solder.

Less than 1/2 of joint side length. (More than 1/2 is selected as defect

#### 7. Product Marking



The left side of the position of the marking is the primary winding side (start of winding).

(6/13)

MECHANICAL PERFORMANCE / ENVIRONMENTAL TEST PERFORMANCE SPECIFICEATIONS

	Test Item	Standard	Test method
CS	Inductance	Refer to Table 1.	LCR meter (HP4285A or equivalent)
RICAL	DC resistance	Refer to Table 1.	DC ohm meter (HIOKI3227 or equivalent)
ECT	Rated current	Refer to Table 1.	Maximum DC value that does not cause inductance to decrease more than 30% with DC bias and does not cause temperature to increase by more than 40 deg C.
CHAR	Self resonant frequency	Refer to Table 1.	Impedance/material analyzer (HP4291A or equivalent)
MECHANICAL CHARACTERISTICS	Resistance to deflection	No damage.	The test samples shall be soldered to the test board by the reflow soldering conditions show in Table 6.  As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.  Porce Rod  Rod  Rod  Rod  Rod  Rod  Rod  Rod
	Adhesion of Terminal electrode	Shall not come off PC board	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 6.  Applied force: 10 N to X and Y directions.  Duration: 5 s.  Solder cream thickness: 0.15 mm (Refer to recommended Land Pattern Dimensions defined in "Precaution")
	Body strength	No damage.	Applied force: 30 N Duration: 10 s  R0.5 mm  Sample

(7/13)

MECHANICAL PERFORMANCE / ENVIRONMENTAL TEST PERFORMANCE SPECIFICEATIONS

	Test Item	Standard	Test method				
	Resistance to vibration	□L/L → within±10 % No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 6. Then it shall be submitted to below test conditions.  Frequency range 10Hz ~55 Hz  Total Amplitude 1.5 mm (May not exceed acceleration 196 m/S²)  Sweeping Method 10Hz to 55Hz to 10 Hz for 1 min.  For 2 hours on each X, Y,				
ESTS	Resistance to soldering heat (Reflow)	ΔL/L : within±10 % No abnormality observed in appearance.	The test sample shall be exposed to reflow oven at 230±5 deg C for 40 seconds, with peak temperature at 260±5 deg C for 5 seconds, 2 times.  Test board thickness: 1.0 mm				
	Solderability	At least 90 % of surface of terminal electrode is covered by new solder.	Test board material: glass epoxy-resin  The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.  Flux: Methanol solution containing rosin 25 %.  Solder Temperature 245±5 deg C  Time 5±1.0 s.				
<b> -</b>	Temperature	ΔL/L : within±20 %	Immersing Speed 25 mm/s  Measurement of inductance shall be taken at temperature				
NVIRONMENT	characteristics	No abnormality observed in appearance.	range within -25 deg C to +85 deg C. With reference to inductance value at +20 deg C, change rate shall be calculated.				
ENVI	Thermal shock	ΔL/L : within±10 % No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 6. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence.  The temperature cycle shall be repeated 100 cycles.  Conditions of steps for 1 cycle				
			Step         Temperature         Time (min)           1         -40±3 deg C         30±3           2         Room Temp.         3 maximum           3         85±2 deg C         30±3           4         Room Temp         3 maximum				
	Low temperature life test	ΔL/L : within±10 % No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 6. After that, the test samples shall be placed at test conditions as shown in below table.				
			Temperature -40±2 deg C Time 500 +24/-0 h				

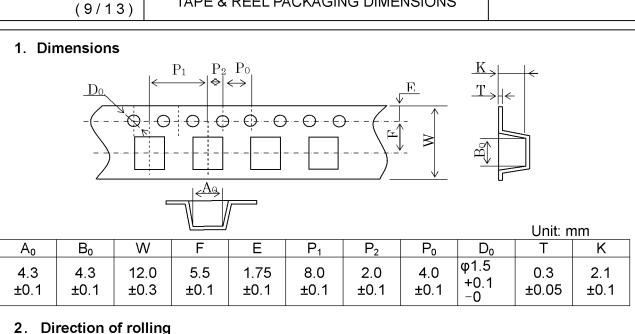
(8/13)

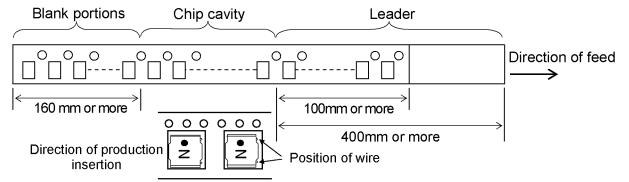
MECHANICAL PERFORMANCE / ENVIRONMENTAL TEST PERFORMANCE SPECIFICEATIONS

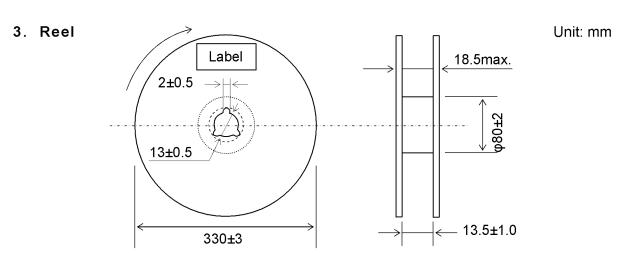
	Test Item	Standard	Test method		
	Loading at high temperature life test	ΔL/L : within±10 % No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 6.  The test samples shall be placed in thermostatic oven set at specified temperature and applied the rated current continuously as shown in below table.		
			Temperature 85±2 deg C		
			Applied current Rated current (Refer to Table 1)		
			Time 500 +24/-0 h		
NVIRONMENT TESTS	Damp heat life test	ΔL/L : within±10 % No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 6.  The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.  Temperature 60±2 deg C		
RO RO			Humidity         90∼95 %RH           Time         500 +24/-0 h		
			11110   300 124/-011		
Ш	Loading under damp heat life test	ΔL/L : within±10 % No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 6. The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.		
			Temperature 60±2 deg C		
			Humidity 90~95 %RH		
			Applied current Rated current (Refer to Table 1)		
			Time 500 +24/-0 h		

Standard	Unless atherwise specified the test samples are placed at room tempera
measuring condition	Unless otherwise specified, the test samples are placed at room temperature and humidity and measured within 48 hours after exposure to test conditions.

## Table 4 TAPE & REEL PACKAGING DIMENSIONS







Label position: On the opposite side of sprocket holes side of reel

#### 4. Top tape strength



# Table 5 (10/13) PACKING FORM

#### 1. The number of components

A tape & reel package contains 3500 inductors.

#### 2. Tape and Reel

Emboss carrier tape: 12mm-width and 8 mm-pitch

Reel: 330 mm-diameter

#### 3. The allowable number of empty chip cavities

Maximum two (2) chip cavities missing product may exist in a reel but they may not be consecutive two cavities.

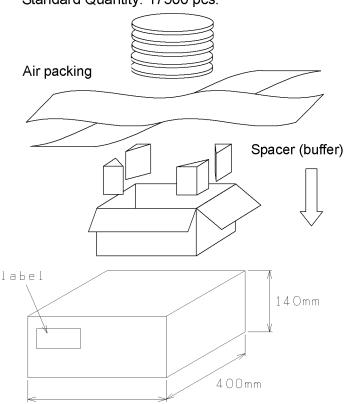
#### 4. Marking

The following items shall be marked legibly on per tape & reel package.

- (1) Customer part No.
- (2) Our part No.
- (3) Supplier name (Taiyo Yuden Co., Ltd.)
- (4) Control No.
- (5) Date (stamp)
- (6) Quantity
- (7) Country of the origin

#### 5. Dimensions of packing box (for Tape & Reel package)

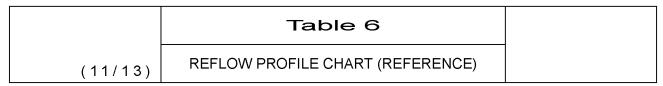
Standard Quantity: 17500 pcs.

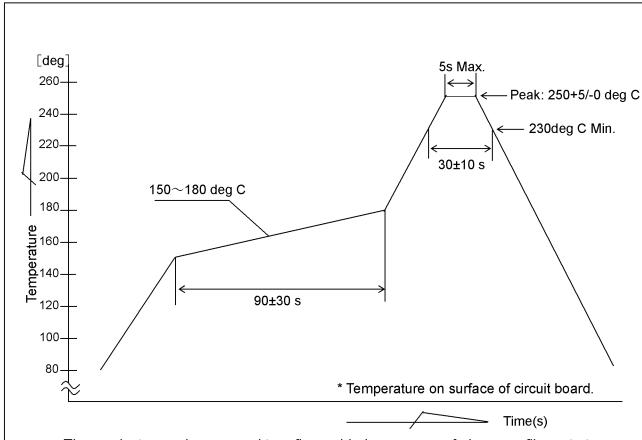


A packing box contains 5 reels maximum.

400mm

(Unit: mm)





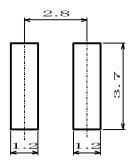
The products may be exposed to reflow soldering process of above profile up to two times.

#### Precautions

(12/13)

#### 1. Surface Mounting

- Mounting and soldering conditions should be checked beforehand.
- · Applicable soldering process to this products is reflow soldering only.
- · Recommended Land-Pattern :



(Unit: mm)

#### 2. Handling

- Keep the products away from all magnets and magnetic objects.
- Be careful not to subject the products to excessive mechanical shocks.
- Please avoid applying impact to the products after mounted on pc board.
- · Avoid ultrasonic cleaning.

#### 3. Storage

To prevent deterioration of the solderability of terminal electrodes and/or the packing materials of the products, please store the products under following storage conditions.

Ambient temperature range

0 deg C to 40 deg C

Humidity

70 % RH maximum

Even under the ideal storage conditions, solderability of inductor's electrode deteriorates as time passes, so inductors should be used within 6 months after the delivery time.

#### 4. Regarding Regulations

- Any Class- I or Class- II ozone-depleting substance (ODS) listed in the Clean Air Act in US for regulation is not included in the products or applied to the products at any stage of whose manufacturing processes.
- · Certain brominated flame retardants (PBBs, PBDEs) are not used at all.
- The products of this specifications are not subject to the Export Trade Control Order in Japan or the Export Administration Regulations in US.

#### 5. RoHS compliance

This product conforms to "RoHS compliance".

#### 6. Production Sites and country of origin

TAIYO YUDEN (PHILIPPINES) INC.

#### Precautions

(13/13)

#### 7. Guarantee

The guaranteed operating conditions of the products are in accordance with the conditions specified in this specifications.

Please note that Taiyo Yuden Co., Ltd. takes no responsibility for any failure and/or abnormality which is caused by use under other than the aforesaid operating conditions.

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